

FEATURES

- Average Forward Current:I_{F(AV)}=3A
- Polarity: Color band denotes cathode

Package Marking and Ordering Information

Product ID	Pack	Marking	Qty(PCS)			
SS32-SS310	SMC	SS3 *	2000			



SMC



★:From 2-10

MAXIMUM RATINGS (Ta=25 unless otherwise noted)

lt	Symbol	Unit	Test Conditions	SS3								
Item				2	3	4	5	6	8	9	10	
Repetitive Peak Reverse Voltage	V _{RRM}	V		20	30	40	50	60	80	90	100	
Maximum RMS Voltage	V _{RMS}	V		14	21	28	35	42	56	63	70	
Average Forward Current	I _{F(AV)}	A	60Hz Half-sine wave, Resistance load,FIG.1	3.0								
Surge(Non-repetitive)Forward Current	I _{FSM}	A	60Hz Half-sine wave, 1 cycle,Ta=25℃	80								
Junction Temperature	TJ	°C		-5	-55~+125 -55~+150							
Storage Temperature	T _{STG}	°C		-55 ~ +150								

ELECTRICAL CHARACTERISTICS (Ta=25 unless otherwise specified)

	•		Test Condition		SS3								
ltem	Symbol	Unit			2	3	4	5	6	8	9	10	
Peak Forward Voltage	V _F	V	I _F =		0.55		0.	70	0.85				
Peak Reverse Current	I _{RRM1}	mA	V _{RM} =V _{RRM}	Ta=25℃		0.1					0.02		
	I _{RRM2}	mA		T _a =100℃			5				2		
Thermal	$R_{\theta_{J}-A}$	°C/	Between junct	60									
Resistance(Typical)	R _{θJ-L}	W	Between junct	tion and terminal	20								

Notes:

Thermal resistance from junction to ambient and from junction to lead mounted on P.C.B. with 0.27" x 0.27" (7.0 mm x 7.0 mm) copper pad areas



SS32-SS310 SCHOTTKY RECTIFIER DIODES

Typical Characteristics

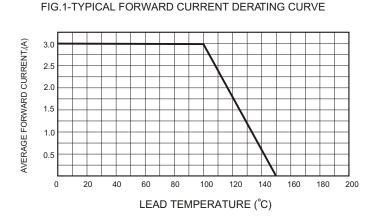


FIG.3-MAXIMUM NON-REPETITIVE FORWARD

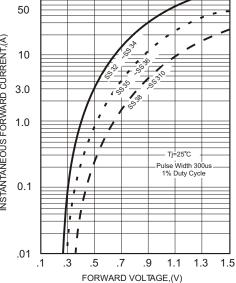
SURGE CURRENT 100 PEAK FORWAARD SURGE CURRENT,(A) 80 60 8.3ms Single Half Ti=25°C Sine Wave 40 JEDEC method 20 0 100 1 5 10 50

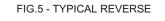
NUMBER OF CYCLES AT 60Hz

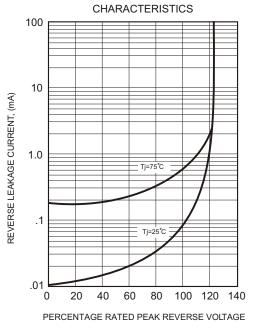
FIG.4-TYPICAL JUNCTION CAPACITANCE 700 600 JUNCTION CAPACITANCE, (pF) 500 400 300 200 100 0 L .01 .05 .1 .5 5 10 50 100 1 REVERSE VOLTAGE,(V)

CHARACTERISTICS 50 INSTANTANEOUS FORWARD CURRENT,(A) 10 3.0 1.0 Tj=25°C Pulse Width 300us 1% Duty Cycle . 0.1 1 .01

FIG.2-TYPICAL FORWARD

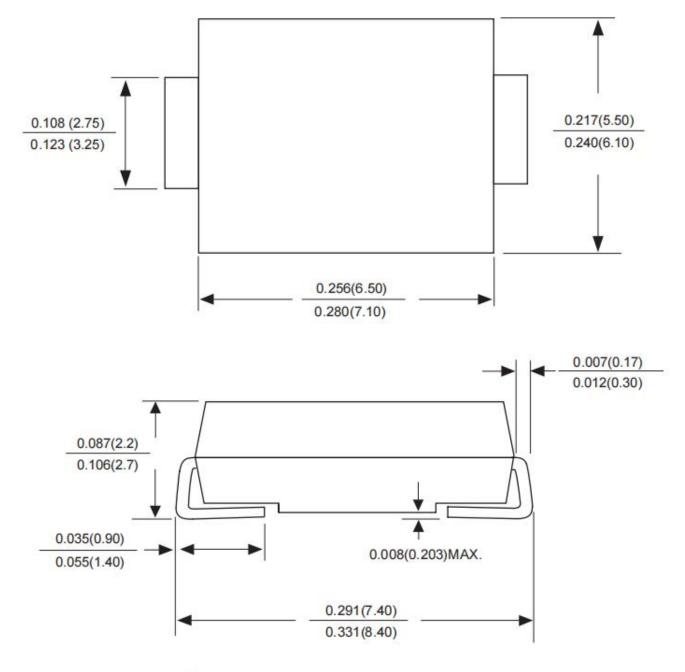








SMC Package Outline Dimensions



Dimensions in inches and (millimeters)



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